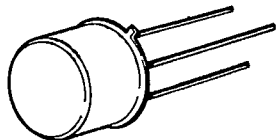


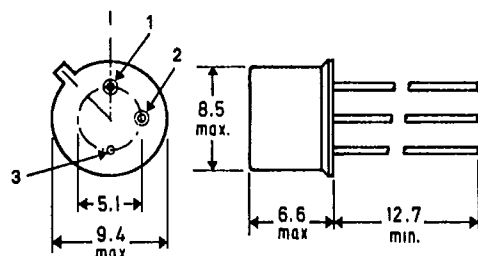
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[查询"2N6795"供应商](#)**SEMELAB****2N 6795****2N 6796****MECHANICAL DATA**

Dimensions in mm

MOS POWER**N-Channel Enhancement Mode****APPLICATIONS**

- FAST SWITCHING
- MOTOR CONTROLS
- POWER SUPPLIES

PIN 1 - Source PIN 2 - Gate PIN 3 Drain and Case

T039

ABSOLUTE MAXIMUM RATINGS ($T_{CASE} = 25^{\circ}C$ unless otherwise specified)

Parameter	2N 6795	2N 6796
V_{DS}	80V	100V
V_{DGR}	80V	100V
$I_D @ T_C = 25^{\circ}C$		$\pm 8A$
$I_D @ T_C = 100^{\circ}C$		$\pm 5A$
I_{DM}		$\pm 25A$
V_{GS}		$\pm 40V$
$P_D @ T_C = 25^{\circ}C$		25W
$P_D @ T_C = 100^{\circ}C$		10W
Junction to case		0.2 W/ $^{\circ}C$
Junction to ambient		0.005 W/ $^{\circ}C$
T_J		-55 to 150 $^{\circ}C$
T_{stg}		storage temperature range
Lead temperature		(1/16" from case for 10 secs.) 300 $^{\circ}C$

(I) Pulse test: Pulse width $\leq 300\mu sec$, duty cycle $\leq 2\%$

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2N 6795 2N 6796

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ELECTRICAL CHARACTERISTICS (T_{case} = 25°C unless otherwise specified)

STATIC

Parameter	Type	Min.	Typ.	Max.	Units	Test Conditions	
BV _{DSS}	Drain-Source Breakdown Voltage	2N6795	60*			V	V _{GS} = 0 I _D = 1.0 mA
		2N6796	100*			V	
V _{GS(th)}	Gate-Threshold Voltage	All	2.0*	4.0*		V	V _{DS} = V _{GS} , I _D = 1.0 mA
I _{GSSF}	Gate-Body Leakage Forward	All		100*		nA	V _{GS} = 20V
I _{GSSR}	Gate-Body Leakage Reverse	All		-100*		nA	V _{GS} = -20V
I _{DSS}	Zero Gate Voltage Drain Current	All		1.0*		mA	V _{DS} = Max. Rating, V _{GS} = 0
		All		4.0*		mA	V _{DS} = Max. Rating, V _{GS} = 0 T _C = 125°C
I _{D(on)}	On-State Drain Current ¹	2N6795	8.0			A	V _{DS} > 2V _{DS(on)} , V _{GS} = 10V
		2N6796	8.0			A	V _{DS} > 2V _{DS(on)} , V _{GS} = 10V
V _{DS(on)}	Static Drain-Source On-State Voltage ¹	2N6795		1.56*		V	V _{GS} = 10V, I _D = 8.0A
		2N6796		1.56*		V	V _{GS} = 10V, I _D = 8.0A
R _{DS(on)}	Static Drain-Source On-State Resistance ¹	2N6795		0.18*		Ω	V _{GS} = 10V, I _D = 5.0A
		2N6796		0.18*		Ω	V _{GS} = 10V, I _D = 5.0A
R _{DS(on)}	Static Drain-Source On-State Resistance ¹	2N6795		0.35*		Ω	V _{GS} = 10V, I _D = 5A, T _C = 125°C
		2N6796		0.35*		Ω	V _{GS} = 10V, I _D = 5A, T _C = 125°C


DYNAMIC

g _{fs}	Forward Transconductance ¹	All	3.0*	9.0*		S (U)	V _{DS} > 2V _{DS(on)} , I _D = 5A
C _{iss}	Input Capacitance	All	350*	900*		pF	V _{GS} = 0, V _{DS} = 25V f = 1 MHz
C _{oss}	Output Capacitance	All	150*	500*		pF	
C _{rss}	Reverse Transfer Capacitance	All	50*	150*		pF	
t _{d(on)}	Turn-On Delay Time	All		30*		ns	V _{DD} = 30V, I _D = 5A R _g = 7.5Ω, R _L = 6Ω (MOS FET switching times are essentially independent of operating temperature.)
t _r	Rise Time	All		75*		ns	
t _{d(off)}	Turn-Off Delay Time	All		40*		ns	
t _f	Fall Time	All		45*		ns	

THERMAL RESISTANCE

R _{thJC}	Junction-to-Case	All		5.0*		°C/W	
R _{thJA}	Junction-to-Ambient	All		170		°C/W	Free Air Operation

BODY-DRAIN DIODE RATINGS AND CHARACTERISTICS

I _S	Continuous Source Current (Body Diode)	2N6795			-8*	A	Modified MOS POWER symbol showing the internal P-N junction rectifier. 
		2N6796			-8*	A	
I _{SM}	Source Current ¹ (Body Diode)	2N6795			-25	A	
		2N6796			-25	A	
V _{SD}	Diode Forward Voltage ¹	2N6795	-0.75*		-1.5*	V	T _C = 25°C, I _S = -8A, V _{GS} = 0
		2N6796	-0.75*		-1.5*	V	T _C = 25°C, I _S = -8A, V _{GS} = 0
t _{rr}	Reverse Recovery Time	All		300		ns	T _J = 150°C, I _F = I _S , dI _F /d _S = 100 A/μs

1 Pulse Test: Pulse Width < 300 μsec, Duty Cycle < 2%

*JEDEC Registered Values

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